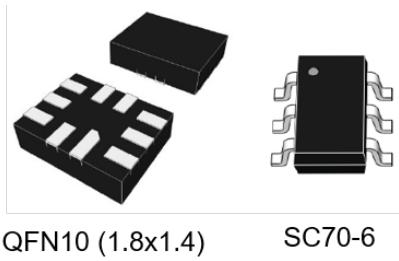


High/low-side, bidirectional, zero-drift current sense amplifiers



QFN10 (1.8x1.4)

SC70-6

Features

- Wide common mode voltage: -0.3 to 26 V
- Offset voltage: $\pm 35 \mu\text{V}$ max. (TSC210)
- 2.7 to 26 V supply voltage
- Different gain available
 - TSC210 (200 V/V)
 - TSC211 (500 V/V)
 - TSC212 (1000 V/V)
 - TSC213 (50 V/V)
 - TSC214 (100 V/V)
 - TSC215 (75 V/V)
- Gain error: $\pm 1\%$ max.
- Offset drift: $0.1 \mu\text{V}/^\circ\text{C}$ max.
- Gain drift: $20 \text{ ppm}/^\circ\text{C}$ max.
- Quiescent current: $100 \mu\text{A}$
- QFN10 (1.8x1.4) and SC70-6

Applications

Product status link

TSC210, TSC211, TSC212, TSC213,
TSC214 and TSC215

- Telecom equipment
- Power management
- Notebook computers
- Industrial applications
- Battery chargers

Description

The TSC210, TSC211, TSC212, TSC213, TSC214 and TSC215 are a series of zero-drift current sense amplifiers that can sense current via a shunt resistor over a wide range of common mode voltages from -0.3 to +26 V, whatever the supply voltage is. They are available in three different versions, each of them having a different gain. The TSC21x are designed with a specific zero-drift architecture, which can achieve high precision.

The TSC21x are current sense amplifiers that may be used in various functions such as precision current measurement, over current protection, current monitoring, feedback loops.

These devices fully operate over the broad supply voltage range of 2.7 to 26 V and over the industrial temperature range -40 to 125°C .

1 Pin connections and description

Figure 1. Pin connections (top view)

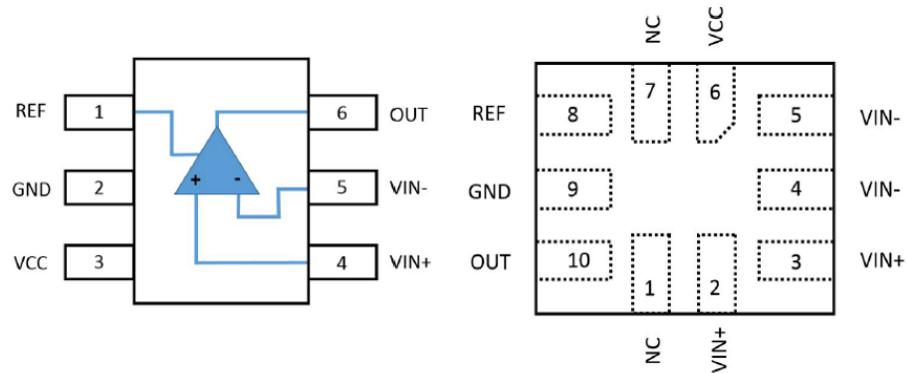


Table 1. Pin description

Name	SC70-6	QFN10	Description
REF	1	8	Reference voltage input
GND	2	9	Ground
Vcc	3	6	Power supply voltage
Vin+	4	2, 3	Connection to the external sense resistor
Vin-	5	4, 5	Connection to the external sense resistor
OUT	6	10	Output voltage
NC		1, 7	Not connected ⁽¹⁾

1. Pins can be left floating or connected to VCC or GND.

2

Block diagram

Figure 2. Block diagram

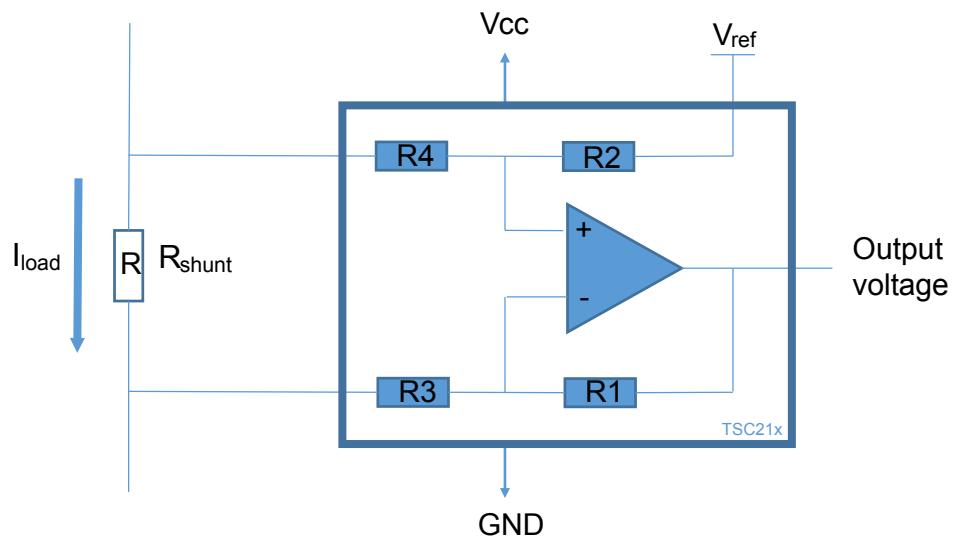


Table 2. Resistors and gain values

Product	R1 and R2	R3 and R4	Gain
TSC210	1 MΩ	5 kΩ	200
TSC211	1 MΩ	2 kΩ	500
TSC212	1 MΩ	1 kΩ	1000
TSC213	1 MΩ	20 kΩ	50
TSC214	1 MΩ	10 kΩ	100
TSC215	1 MΩ	13.3 kΩ	75

3

Absolute maximum ratings and operating conditions

Table 3. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{CC}	Supply voltage ⁽¹⁾	26	V
V_{IN}	Differential voltage between input pins (I_{in+} , I_{in-})	-26 to +26	V
	Common mode voltage on input pins	Gnd-0.3 to 26	
Ref	Reference input voltage	Gnd-0.3 to $V_{CC}+0.3$	V
I_{in}	Input current to any pin ⁽²⁾	5	mA
V_{out}	Output voltage	Gnd-0.3 to $V_{CC}+0.3$	V
T_{Lead}	Lead temperature for 10 s ⁽³⁾	260	°C
T_{stg}	Storage temperature	-65 to 150	°C
T_j	Junction temperature	150	°C
$R_{th\text{-}ja}$	Thermal resistance junction to ambient ⁽⁴⁾⁽⁵⁾	124	°C/W
	QFN10	232	
ESD	HBM: human body model ⁽⁶⁾	3000	V
	CDM: charged device model ⁽⁷⁾	1000	
	Latch-up immunity	200	mA

1. All voltage values, except the differential voltage are with respect to the network ground terminal.

2. Due to AMR on input current (I_{in}), differential voltage may be limited.

3. Reflow at peak temperature of 260 °C. Time above 255 °C must not exceed 30 s.

4. Short-circuits can cause excessive heating and destructive dissipation.

5. R_{th} are typical values.

6. According to JEDEC standard JESD22-A114F.

7. According to ANSI/ESD STM5.3.1.

Table 4. Operating conditions

Symbol	Parameter	Value	Unit
V_{CC}	Supply voltage	2.7 to 26	V
V_{icm}	Common mode voltage on input pins	-0.3 to +26	V
T	Operating free-air temperature range	-40 to 125	°C

4

Electrical characteristics

**Table 5. Electrical characteristics, $T = 25^\circ\text{C}$, $V_{\text{SENSE}} = V_{\text{IN+}} - V_{\text{IN-}}$ (unless otherwise specified),
TSC210, TSC213, TSC214, TSC215: $V_{\text{CC}} = 5 \text{ V}$, $V_{\text{IN+}} = 12 \text{ V}$, $V_{\text{REF}} = V_{\text{CC}}/2$ (unless otherwise specified),
TSC211, TSC212: $V_{\text{CC}} = 12 \text{ V}$, $V_{\text{IN+}} = 12 \text{ V}$, $V_{\text{REF}} = V_{\text{CC}}/2$ (unless otherwise specified)**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit	
Power supply							
V_{CC}	Supply voltage		2.7		26	V	
I_{CC}	Quiescent current	$V_{\text{SENSE}} = 0 \text{ mV}$		65	100	μA	
		$T_{\text{min.}} < T < T_{\text{max.}}$			115		
Input							
V_O	Offset voltage (RTI) ⁽¹⁾						
	TSC210, TSC211, TSC212	$V_{\text{SENSE}} = 0 \text{ mV}$	-35		35	μV	
	TSC214, TSC215	$V_{\text{SENSE}} = 0 \text{ mV}$	-60		60		
	TSC213	$V_{\text{SENSE}} = 0 \text{ mV}$	-100		100		
$ \Delta V_O/\Delta T $	Offset voltage variation (RTI) vs. temperature	$V_{\text{SENSE}} = 0 \text{ mV},$ $T_{\text{min.}} < T < T_{\text{max.}}$		0.05	0.3	$\mu\text{V}/^\circ\text{C}$	
CMRR	Common mode rejection ratio						
	TSC210, TSC211, TSC212, TSC214, TSC215	$V_{\text{IN+}} = 0 \text{ to } 26 \text{ V},$ $V_{\text{SENSE}} = 0 \text{ mV},$ $T_{\text{min.}} < T < T_{\text{max.}}$	105	140		dB	
	TSC213	$V_{\text{in+}} = 0 \text{ to } 26 \text{ V},$ $V_{\text{SENSE}} = 0 \text{ mV},$ $T_{\text{min.}} < T < T_{\text{max.}}$	100	120			
PSRR	Power supply rejection ratio	$V_{\text{CC}} = 2.7 \text{ to } 26 \text{ V}$ $V_{\text{IN+}} = 18 \text{ V}$, $V_{\text{SENSE}} = 0 \text{ mV}$		0.1	10	$\mu\text{V/V}$	
I_{IB}	Input bias current	$V_{\text{SENSE}} = 0 \text{ mV}$	15	28	35	μA	
I_{IO}	Input offset current	$V_{\text{SENSE}} = 0 \text{ mV}$		0.02			
Output							
G	Gain	TSC210		200		V/V	
		TSC211		500			
		TSC212		1000			
		TSC213		50			
		TSC214		100			
		TSC215		75			
E_G	Gain error	$V_{\text{SENSE}} = -5 \text{ to } +5 \text{ mV}$ $T_{\text{min.}} < T < T_{\text{max.}}$		0.02	± 1	%	
T_G	Gain error vs. temperature	$T_{\text{min.}} < T < T_{\text{max.}}$		7	20	$\text{ppm}/^\circ\text{C}$	
NLE	Linearity error	$V_{\text{SENSE}} = -5 \text{ to } +5 \text{ mV}$		0.01		%	

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
C_L	Maximum capacitive load	No sustained oscillation		470		pF
V_{sw^+}	Output swing close to V_{CC}	$R_L = 10 \text{ k}\Omega$ to Gnd $T_{min.} < T < T_{max.}$	$V_{CC} - 0.2$	$V_{CC} - 0.05$		V
V_{sw^-}	Output swing close to Gnd	$R_L = 10 \text{ k}\Omega$ to Gnd $T_{min.} < T < T_{max.}$		5	30	mV
R_{Load}	Load regulation	$I_{OUT} = -10 \text{ to } +10 \text{ mA}$		0.5		Ω
Dynamic performance						
BW	Bandwidth	$V_{CC} = 5 \text{ V}$, $V_{icm} = 12 \text{ V}$, $Cl = 100 \text{ pF}$				
		TSC210		25		
		TSC211		8		
		TSC212		6		
		TSC213		100		
		TSC214		40		
		TSC215		60		
SR	Slew rate	$V_{CC} = 5 \text{ V}$, $V_{icm} = 12 \text{ V}$, $Cl = 100 \text{ pF}$				
		TSC210		0.2		
		TSC211		0.075		
		TSC212		0.05		
		TSC213		0.85		
		TSC214		0.32		
		TSC215		0.42		
E_N	Noise (RTI) ⁽¹⁾	$f = 1 \text{ kHz}$				
		TSC210		40		
		TSC211		48		
		TSC212		50		
		TSC213		38		
		TSC214		40		
		TSC215		39		

1. RTI stands for "related to input"

5

Typical characteristics

The TSC210 is used for typical characteristics, unless otherwise specified

Figure 3. Input offset voltage production distribution

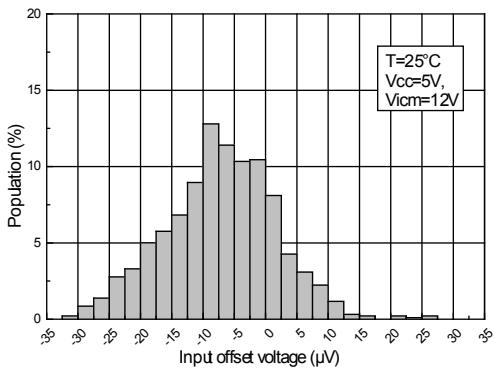


Figure 4. Input offset voltage vs temperature

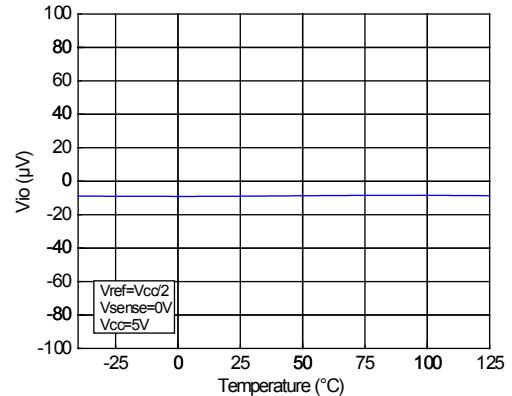


Figure 5. Common-mode rejection ratio production distribution

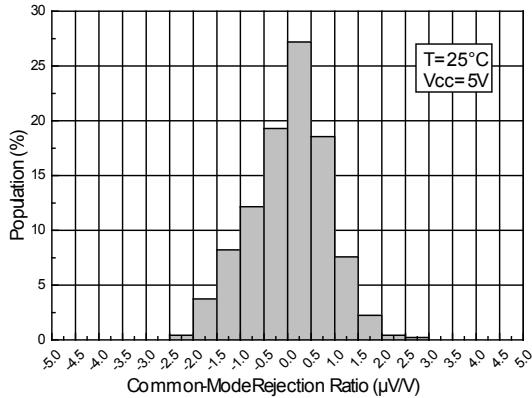


Figure 6. Common mode rejection ratio vs temperature

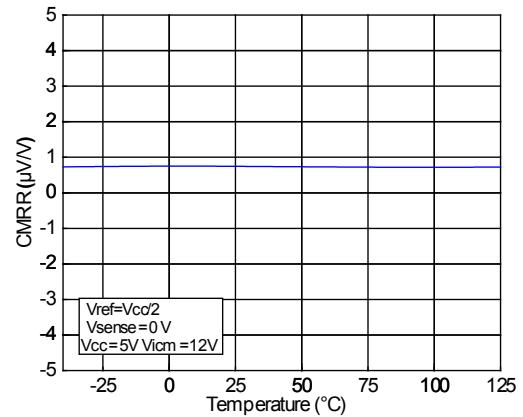


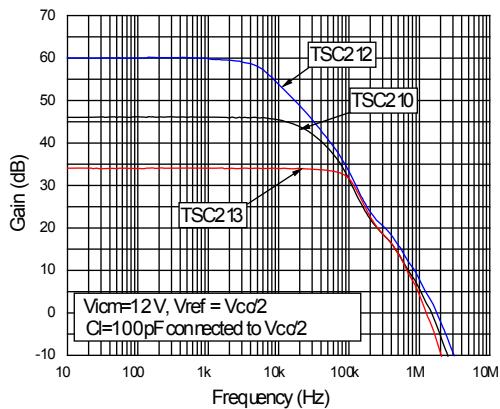
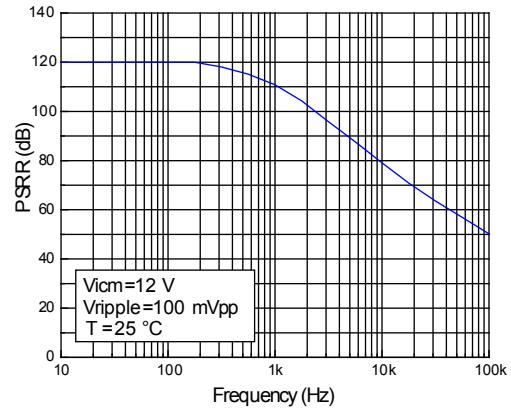
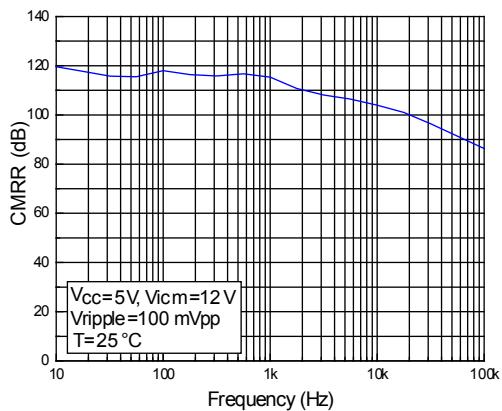
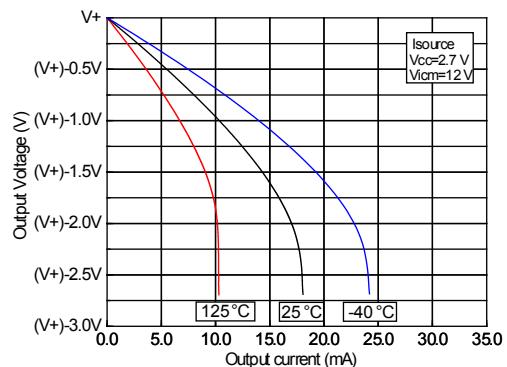
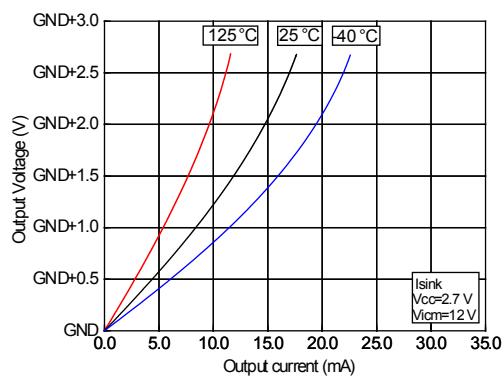
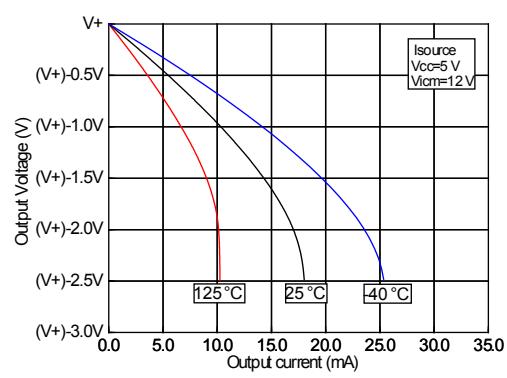
Figure 7. Gain vs frequency

Figure 8. Power supply rejection ratio vs frequency

Figure 9. Common mode rejection ratio vs frequency

Figure 10. Positive output voltage swing vs output current $V_{CC} = 2.7\text{ V}$

Figure 11. Negative output voltage swing vs output current $V_{CC} = 2.7\text{ V}$

Figure 12. Positive output voltage swing vs output current $V_{CC} = 5\text{ V}$


Figure 13. Negative output voltage swing vs output current $V_{CC} = 5\text{ V}$

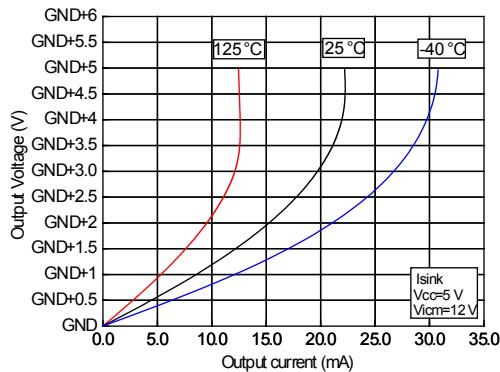


Figure 14. Positive output voltage swing vs output current $V_{CC} = 26\text{ V}$

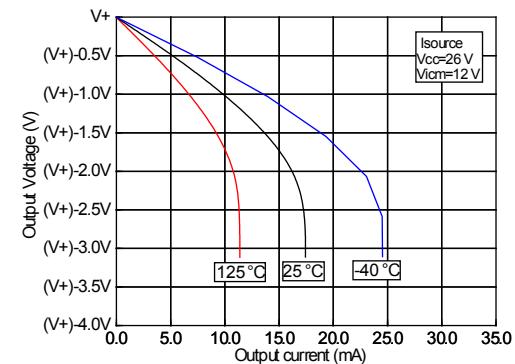


Figure 15. Negative output voltage swing vs output current $V_{CC} = 26\text{ V}$

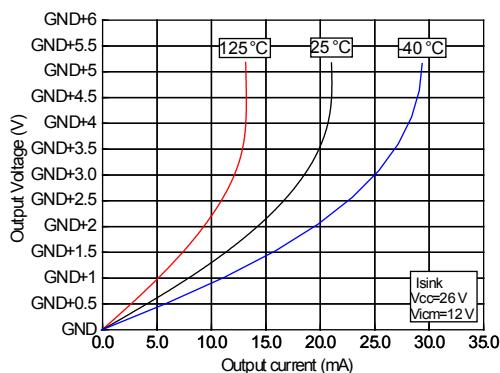


Figure 16. Input bias current vs input common mode voltage with supply voltage = 5 V

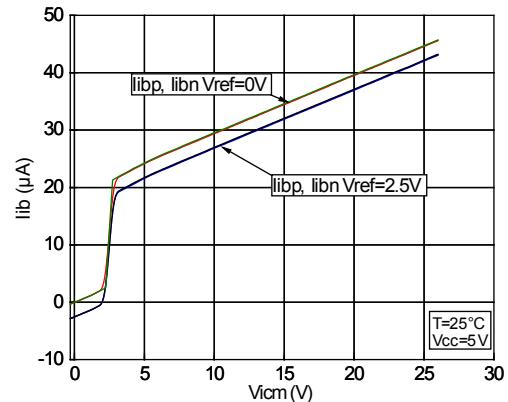


Figure 17. Input bias current vs input common mode voltage with supply voltage = 0 V

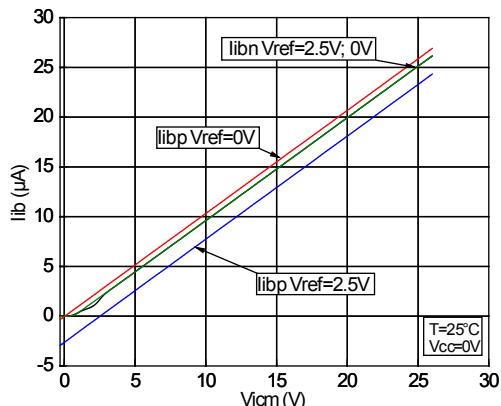


Figure 18. Input bias current vs temperature

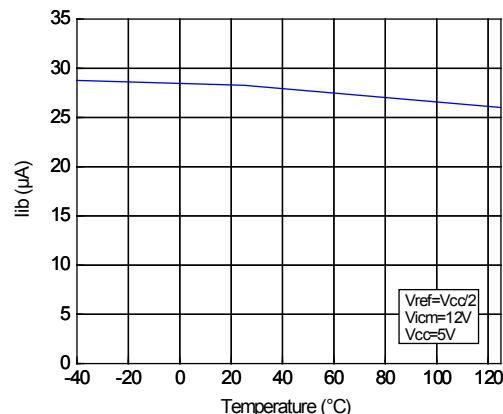


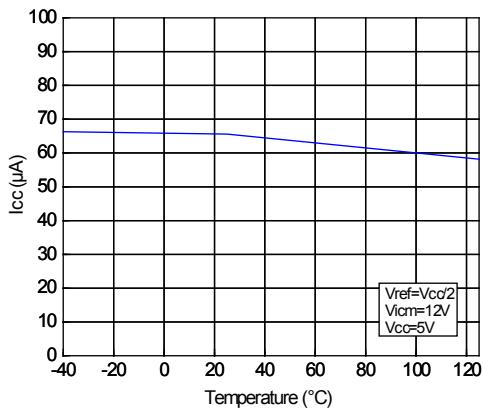
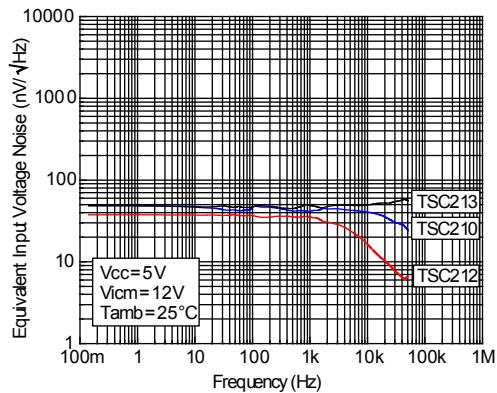
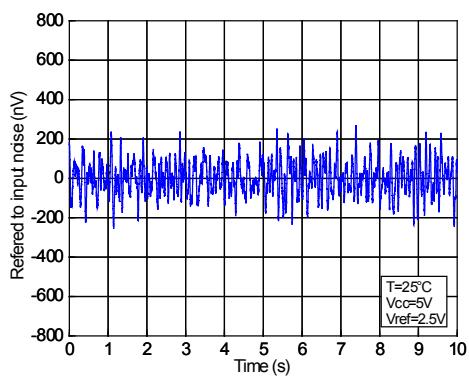
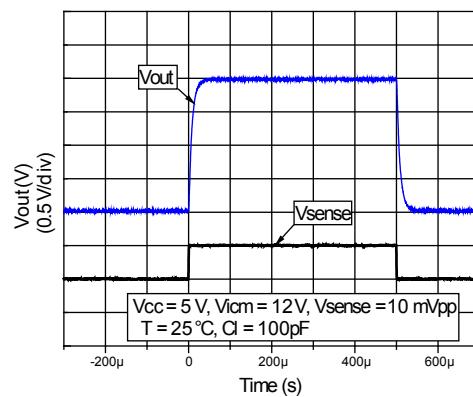
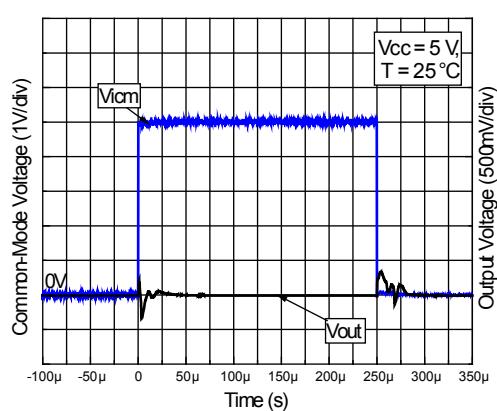
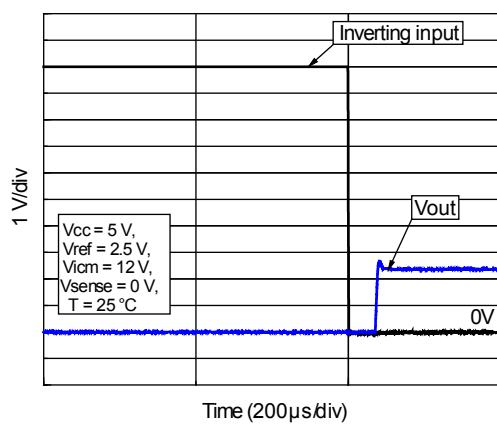
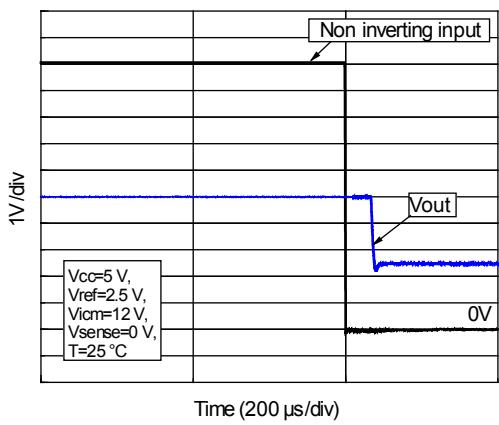
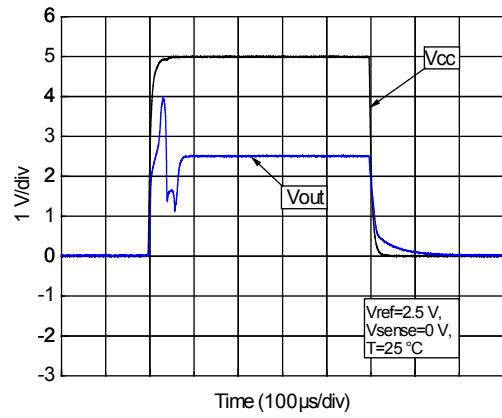
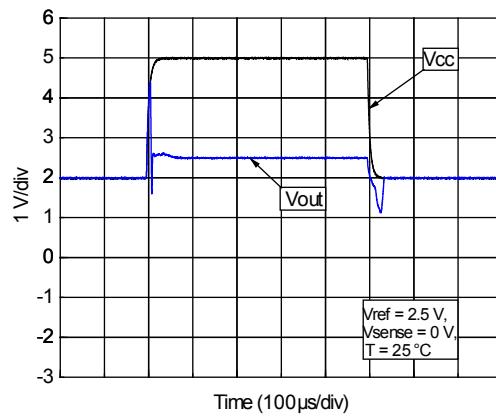
Figure 19. Quiescent current vs temperature

Figure 20. Input referred noise vs frequency

Figure 21. 0.1 Hz to 10 Hz voltage noise (referred to input)

Figure 22. Step response (10-mVpp input step)

Figure 23. Common mode voltage transient response

Figure 24. Inverting differential input overloaded


Figure 25. Non inverting differential input overload**Figure 26. Start-up response****Figure 27. Brownout recovery**

6 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

6.1 SC70-6 package information

Figure 28. SC70-6 package outline

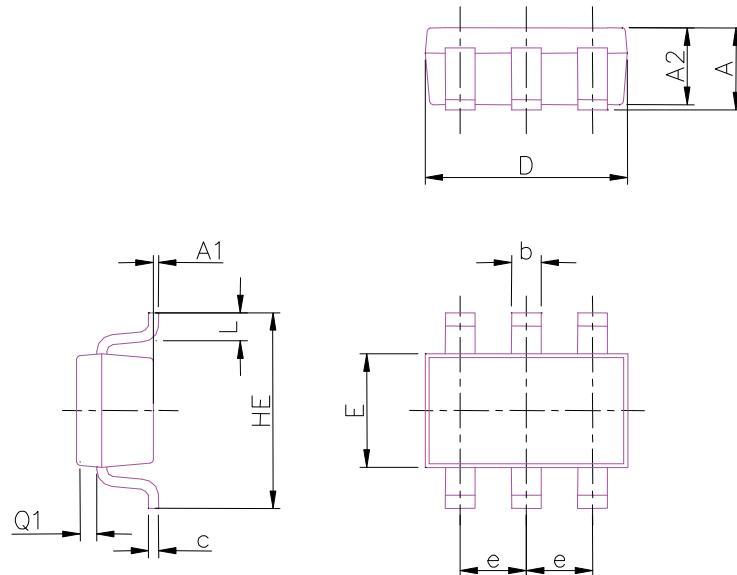
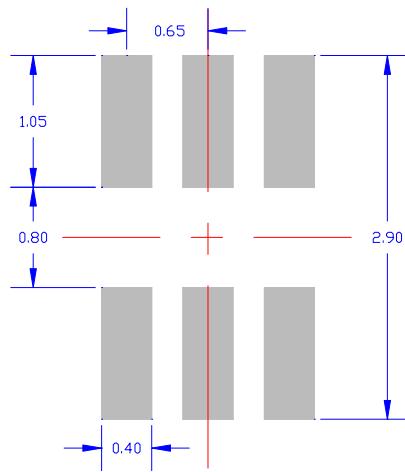


Table 6. SC70-6 mechanical data

Symbol	Millimeters			Inches ⁽¹⁾		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	0.80		1.10	0.037		0.041
A1	0		0.10	0.000		0.004
A2	0.80		1.00	0.035		0.039
b	0.15		0.30	0.008		0.010
c	0.10		0.18	0.004		0.004
D	1.80		2.20	0.078		0.086
E	1.15		1.35	0.050		0.052
e		0.65		0.025		0.026
HE	1.8		2.4	0.083		0.090
L	0.10		0.40	0.013		0.015
Q1	0.10		0.40	0.011		0.013

1. Values in inches are converted from mm and rounded to 4 decimal digits.

Figure 29. SC70-6 recommended footprint



6.2 QFN10 package information

Figure 30. QFN10 package outline

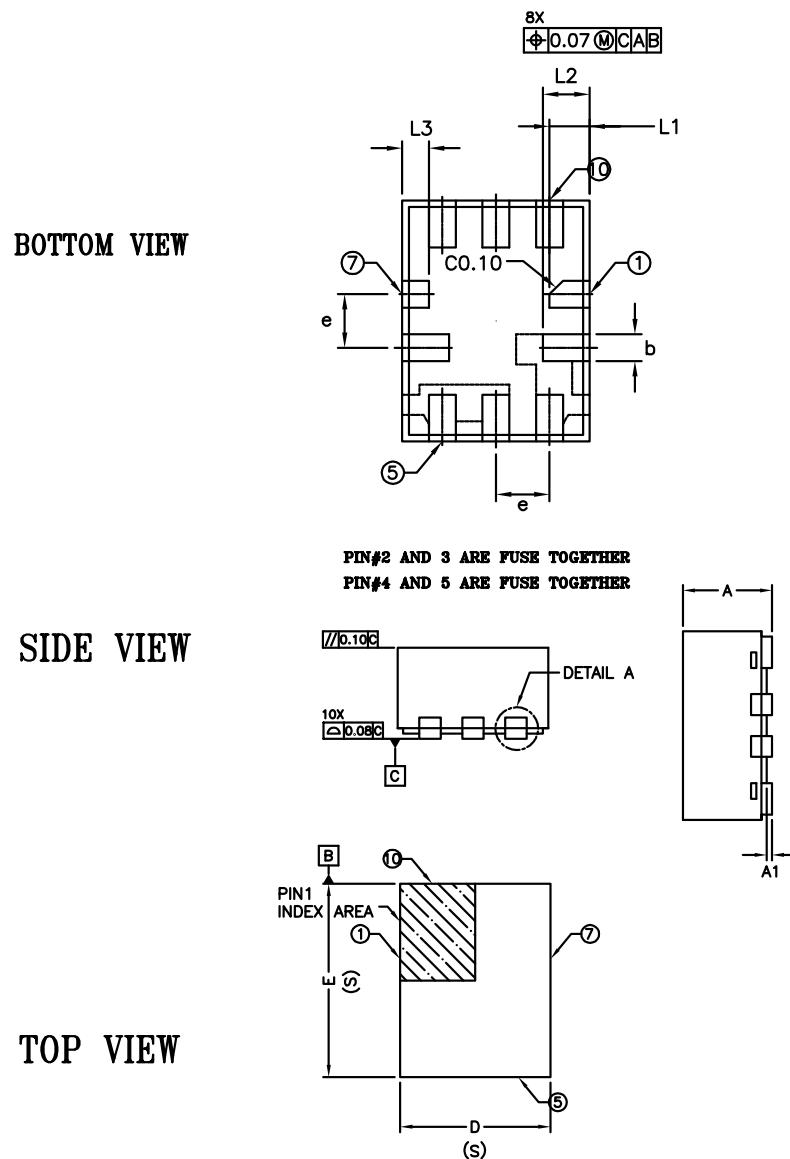


Figure 31. QFN10 detail A package outline

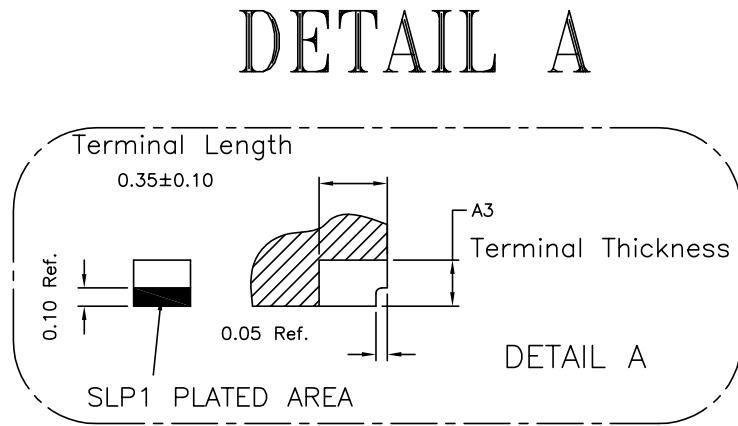
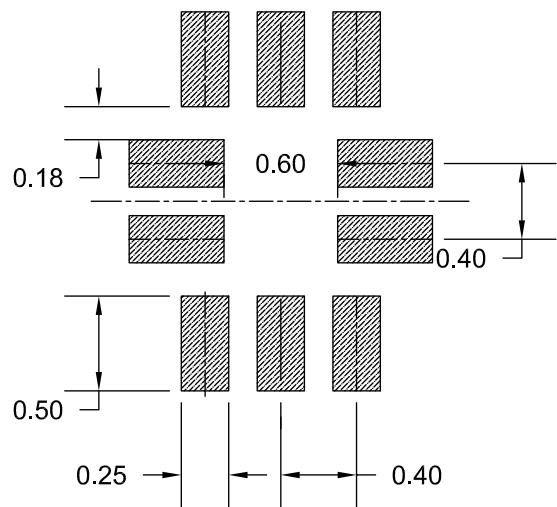


Table 7. QFN10 mechanical data

Symbol	mm		
	Min.	Typ.	Max.
A	0.70	0.75	0.80
A1	0.0		0.05
A3	0.203REF		
b	0.15	0.20	0.25
D	1.35	1.40	1.45
e	0.40 BSC		
E	1.75	1.80	1.85
L1	0.20	0.30	0.40
L2	0.25	0.35	0.45
L3	0.10	0.20	0.30

Figure 32. QFN10 recommended footprint



7

Ordering information

Table 8. Ordering information

Order code	Gain (V/V)	Temperature range	Package	Packing	Marking	
TSC210ICT	200	-40°C to 125°C	SC70-6	Tape and reel	O10	
TSC210IYCT ⁽¹⁾					O16	
TSC210IQT			QFN10		O10	
TSC210IYQT ⁽¹⁾			SC70-6		O16	
TSC211ICT					O11	
TSC211IYCT ⁽¹⁾			SC70-6		O17	
TSC211IQT					O11	
TSC211IYQT ⁽¹⁾			QFN10		O17	
TSC212ICT	1000	-40°C to 125°C	SC70-6	Tape and reel	O12	
TSC212IYCT ⁽¹⁾			SC70-6		O18	
TSC212IQT					O12	
TSC212IYQT ⁽¹⁾			QFN10		O18	
TSC213ICT			SC70-6		O13	
TSC213IYCT ⁽¹⁾					O19	
TSC213IQT			QFN10		O13	
TSC213IYQT ⁽¹⁾			SC70-6		O19	
TSC214ICT					O14	
TSC214IYCT ⁽¹⁾	50	-40°C to 125°C	QFN10	Tape and reel	O1A	
TSC214IQT			SC70-6		O14	
TSC214IYQT ⁽¹⁾					O1A	
TSC215ICT			QFN10		O15	
TSC215IYCT ⁽¹⁾			SC70-6		O1B	
TSC215IQT					O15	
TSC215IYQT ⁽¹⁾			QFN10		O1B	

- Qualified and characterized according to the AEC Q100 and Q003 or equivalent, advanced screening according to the AEC Q001 and Q002 or equivalent.

Revision history

Table 9. Document revision history

Date	Version	Changes
13-Feb-2020	1	Initial release.
27-Feb-2020	2	Update features in cover page and Section 4 Electrical characteristics .
24-Nov-2020	3	Added the part numbers: TSC211, TSC214 and TSC215. Updated cover page. Updated Table 2. Resistors and gain values , Section 4 Electrical characteristics and Section 7 Ordering information .

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